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## PATENT CLAIMS

- 1. Method of producing a generally flat, planar detail, such as an electronic product or a component of such, of a plastically formable material, characterised in that it comprises the steps of:
  - first applying an adhesive cover layer containing colour pigment and a circuit comprising electrical and/or optical conductors, on at least one of the surfaces of the detail, and
  - the form the detail plastically in order to obtain its end form.
- 2. Method according to claim 1 or 2, characterised in that the cover layer is a coloured cover layer.
  - 3. Method according to any of the preceding claims, characterised in that the cover layer is arranged with signs and symbols.
  - 4. Method according to claim 1, characterised in that the plastic forming comprises stamping, drawing, bending, drilling, broaching.
  - 5. Method according to claim 1, characterised in the further step of cleaning the detail before the application of the cover layer.
  - 6. Device for producing a generally flat, planar detail, such as an electronic product or a component of such, of a plastically formable material, characterised in that it comprises means for first applying an adhesive cover layer containing colour pigment and a circuit comprising electrical and/or optical conductors, on at least one of the surfaces of the detail, and means for subsequent forming of the detail plastically in order to obtain its end form.

- 7. Device according to claim 6, characterised in that it comprises means for cleaning the detail before the application of the cover layer.
- 8. Cover layer to be used in the method according to any of the claims 1-5, characterised in that it comprises at least one circuit.
  - 9. Cover layer according to claim 8, characterised in that the circuit comprises functional components.
- 10 10. Cover layer according to claim 9, characterized in that the functional components are electrical or optical.
  - 11. Cover layer according to claim 9, characterised in that the components comprise processors, memory units, light means, audio means, active and passive components, displays, keypads and the like.
  - 12. Detail produced of a cover layer according to any of the claims 8 to 10 and by the method according to claim 1.

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